







DISCRIPTION

FEATURES

Higher Frequency
High Saturation Material
Low EMI Radiation
Pick and PLace
Low DC Resistance

OPTIONS

Tape & Reel is Standard (Qty:2000 Pcs)
Bulk Packing Available for smaller quantites
Tolerance: J=5% and K=10% is Standard,
Tighter Tolerances Available

APPLICATIONS

Electronic Appliances
DC-DC Conversion (Paraller Mode)
Isolation/Coupling (Transformer)
Input Filter (Serial Mode)
EMI / RFI Suppression

PHYSICAL CHARACTERISTICS

- Testing: (Equivalent acceptable)
 Inductance: Reduced by 10% to 20% IDC
- RDC:QuadTech 1880 Milliohmmeter
- IDC Max:Lowers inductance by 10% 20%
- Temperature range: -55°C to +125°C

ELECTRICAL SPECIFICATIONS

Properties	Test conditions		Value	Unit	Tol.
Inductance		L	18	μH	see Site 2
Q factor		Q			min.
DC-resistance		DCR typ.		Ω	typ.
DC-resistance		DCR max.	0,030	Ω	max.
Self-Res. Freq.		SRF		KHz	min.
Test-Freq.				KHz	
Rated Current		IDC	3,00	mA	max.
Saturation Current		ISAT		Α	max.

1. This electronic component is meant to be used in general electronic equipment. Before the incorporation SMT WIRE WOUND DUAL of this component into any equipment with higher and more reliable requirements such as aviation, **CHIP INDUCTORS** aerospace, submarine, nuclear control, transportation, transportation signal, disaster prevention, medical, public information network, etc. or if there is a possibility of injuries or damages to the human body, Edcon -Components must be informed before the stage of design-in. Evaluation checks for safety have to be Part No.: S40002-180 performed on each electronic components used in electrical circuits that require high safety and reliability functions. Customer: DRW: Chang CHKD Young MATL: Chu Chi DATE 26.06.2009 APPD: **FINISH** Vienna 1 from 2 Pong Sheet



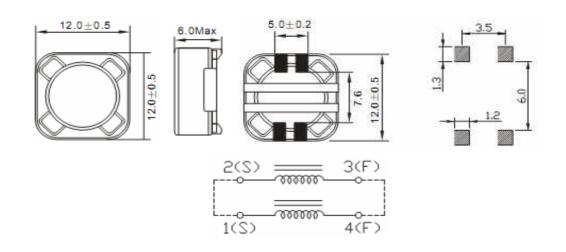






TECHNICAL INFORMATIONS

Dimensions (mm)



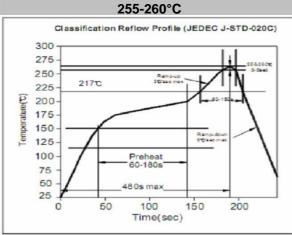
Ordering Information

Serie and Range	T
S40002-180	

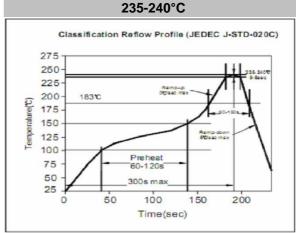
Tolerance	ROHS	Packing	
M	R	TR	

J = 5%	R = ROHS	BU = Bulk Ware
K = 10%	N = non ROHS	TR = Tape Reel
M = 20%		
N = 30%		

Soldering Profile for Lead Free Soldering 255-260°C



Soldering Profile for Lead Free Soldering



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SMT WIRE WOUND DUAL **CHIP INDUCTORS**

Part No.: S40002-180

Customer:

DRW: **CHKD** MATL: Chu Chi DATE 26.06.2009 Chang Young APPD: Pong **FINISH** Vienna Sheet 2 from 2

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